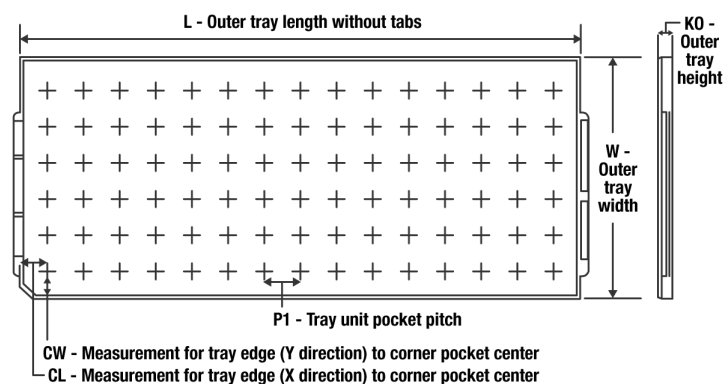


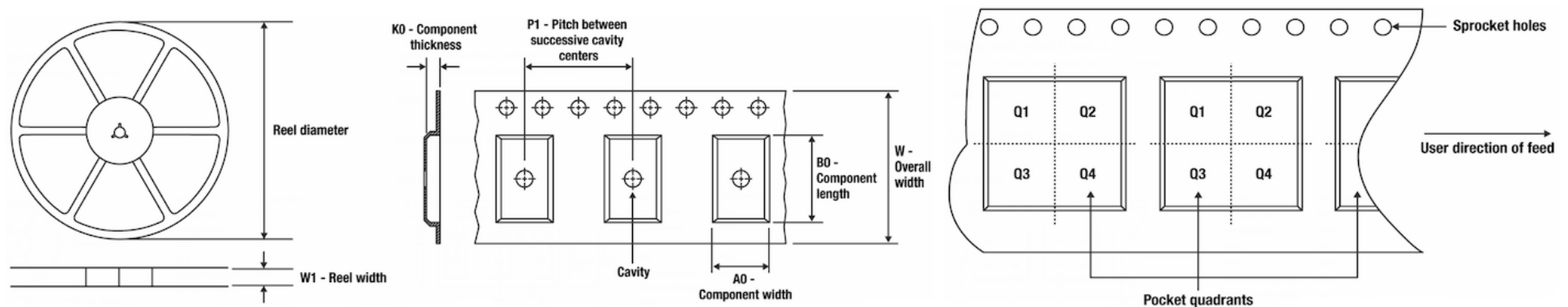
## Carrier Material Report for CC1310F64RHBR

### Tray Information:



| Device        | Package Drawing | Package Type | Pins | SPQ  | Unit Array Matrix | Max Temp (°C) | L (mm) | W (mm) | K0 (μm) | P1 (mm) | CL (mm) | CW (mm) |
|---------------|-----------------|--------------|------|------|-------------------|---------------|--------|--------|---------|---------|---------|---------|
| CC1310F64RHBR | RHB             | VQFN         | 32   | 3000 | 14 x 35           | 150           | 315    | 135.9  | 7620    | 8.8     | 7.9     | 8.15    |

## Tape And Reel Information:



| Device        | Package Name | Package Type | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|--------------|--------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CC1310F64RHBR | RHB          | VQFN         | 32   | 3000 | 330                | 12.4               | 5.3     | 5.3     | 1.1     | 8       | 12     | Q2            |
| CC1310F64RHBR | RHB          | VQFN         | 32   | 3000 | 330                | 12.4               | 5.3     | 5.3     | 1.1     | 8       | 12     | Q2            |

Images above are just a representation of the carrier. Actual carrier may vary. Please reference the dimensions provided in the table.

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